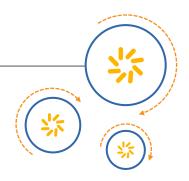


RF360 Europe GmbH

A Qualcomm - TDK Joint Venture



SAW components

SAW duplexer

Small cell & femtocell LTE band 28a

Series/type: B8035

Ordering code: B39771B8035P810

Date: June 10, 2016

Version: 2.0

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SAW duplexer 718.0 / 773.0 MHz

Data sheet

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SAW duplexer 718.0 / 773.0 MHz

Data sheet

1 Application

- Low-loss SAW duplexer for 3G/LTE smallcells systems (Band 28a)
- Usable pass band: 30 MHz
- High power durability in downlink
- Rx = uplink = 703-733 MHz
- Tx = downlink = 758-788 MHz

2 Features

- Package size 2.5±0.1 mm × 2.0±0.1 mm
- Package height 0.5 mm (max.)
- Approximate weight 9 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)



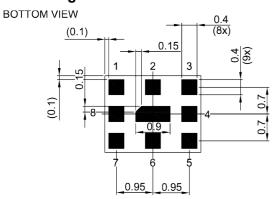
Figure 1: Picture of component with example of product marking.



SAW duplexer 718.0 / 773.0 MHz

Data sheet

3 Package



4 Pin configuration

1 TX

■ 3 RX

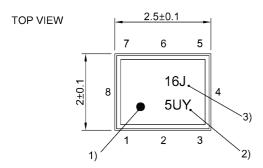
■ 6 ANT

■ 2, 4, 5, 7, Ground 8, 9

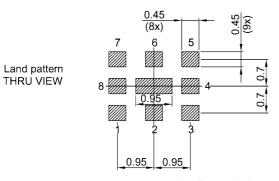
Pad and pitch tolerance ±0.05

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.5 mm (max.). See Sec. Package information (p. 21).



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Data sheet

5 Matching circuit

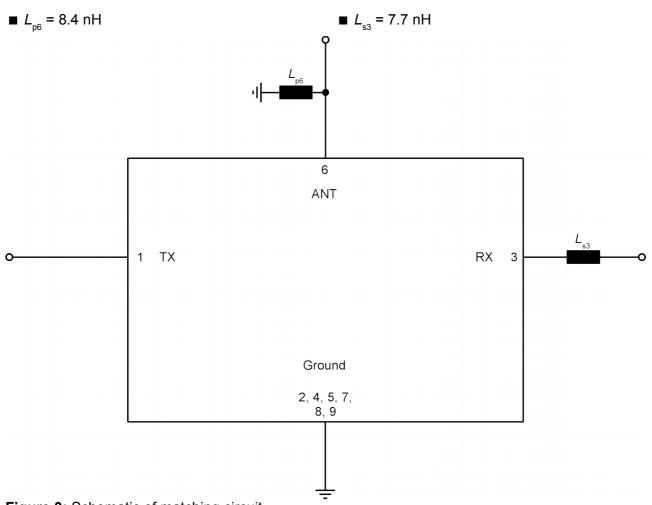


Figure 3: Schematic of matching circuit.



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6 Characteristics

6.1 TX – ANT

Temperature range for specification $T_{\text{SPEC}} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{Tx} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 8.4 nH¹⁾ RX terminating impedance $Z_{RX} = 50 \Omega$ with ser. 7.7 nH¹⁾

Characteristics TX – ANT ²⁾				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	773	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	758 788	MHz		_	2.2	3.2	dB
Amplitude ripple (p-p)			Δα				
	758 788	MHz		_	1.0	2.1	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	758 788	MHz		_	1.8	2.2	
@ ANT port	758 788	MHz		_	1.9	2.2	
Maximum error vector magnitude			EVM _{max} ³⁾				
	760.4 785.6	MHz		_	2.0	4.0	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	50 699	MHz		30	38	_	dB
	703 733	MHz		37	48	_	dB
	733 748	MHz		23	26	_	dB
	803 814	MHz		30	48	_	dB
	880 915	MHz		36	42	_	dB
	925 960	MHz		36	42	_	dB
	1710 1785	MHz		34	36	_	dB
	1805 1880	MHz		33	36	_	dB
	1920 1980	MHz		33	36	_	dB
	2110 2170	MHz		27	34	_	dB
	2400 2500	MHz		27	35	_	dB
	2500 2570	MHz		24	35	_	dB
	2620 2690	MHz		24	31	_	dB
	3000 5150	MHz		10	12	_	dB
	5150 5850	MHz		8	10	_	dB

See Sec. Matching circuit (p. 5).

T is the ambient temperature of the PCB at component position. Specified min./max values are valid for an input power of up to 17 dBm.

³⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.



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Data sheet

6.2 ANT - RX

Temperature range for specification $T_{\text{SPEC}} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{TY} = 50 \Omega$

ANT terminating impedance Z_{ANT} = 50 Ω with par. 8.4 nH¹⁾ RX terminating impedance Z_{RX} = 50 Ω with ser. 7.7 nH¹⁾

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	718	_	MHz
Maximum insertion attenuation			α_{max}				
	703 733	MHz		_	2.2	3.5	dB
Amplitude ripple (p-p)			Δα				
	703 733	MHz		_	1.2	2.3	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	703 733	MHz		_	1.6	2.2	
@ RX port	703 733	MHz		_	1.5	2.3	
Maximum error vector magnitude			EVM _{max} ²⁾				
	705.4 730.6	MHz		_	2.9	6.0	%
Minimum attenuation			$\alpha_{_{min}}$				
	50 694	MHz		28	31	_	dB
	694 695	MHz		22	33	_	dB
	758 788	MHz		46	50	_	dB
	788 803	MHz		30	58	_	dB
	791 821	MHz		30	58	_	dB
	869 894	MHz		30	62	_	dB
	925 960	MHz		30	62	_	dB
	1805 1880	MHz		30	64	_	dB
	1930 1995	MHz		30	64	_	dB
	2110 2170	MHz		30	62	_	dB
	2400 2484	MHz		35	63	_	dB
	2620 2690	MHz		30	63	_	dB
	5150 5850	MHz		35	53	_	dB

¹⁾ See Sec. Matching circuit (p. 5).

²⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.



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Data sheet

6.3 TX - RX

Temperature range for specification $T_{\text{SPEC}} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{Tx} = 50 \Omega$

ANT terminating impedance $Z_{ANT}^{1/2} = 50 \Omega$ with par. 8.4 nH¹⁾ RX terminating impedance $Z_{RX}^{1/2} = 50 \Omega$ with ser. 7.7 nH¹⁾

Characteristics TX – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Minimum isolation			$\boldsymbol{\alpha}_{_{min}}$				
	703 733	MHz		48	51	<u> </u>	dB
	758 788	MHz		49	51	_	dB

¹⁾ See Sec. Matching circuit (p. 5).



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Maximum ratings

Operable temperature	T _{OP} = −40 °C +85 °C	
Storage temperature	T _{STG} = -40 °C +85 °C	
DC voltage	V _{DC} = 0 V	
ESD voltage	V _{ESD} ¹⁾ = 100 V	Machine model.
Input power	P _{IN}	source and load impedance 50 Ω
@ TX port: 758 788 MHz	P _{IN} 30 dBm ²⁾	Pin 30 dBm average – 41dBm peak LTE 5 MHz downlink for 100000 h @ 55 °C.
@ elsewhere	P _{IN} 10 dBm	
@ RX port: 703 733 MHz	P _{IN} 27 dBm ²⁾	LTE 5 MHz uplink for 5000 h @ 55 °C.
Operating lifetime with Output power at antenna		source and load impedance 50 Ω
@ TX port: 758 788 MHz	P _{OUT} t.b.d. dBm ³⁾	Continuous wave for 100000 h @ 55 °C.

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. Time to failure (TTF) according to accelerated power durability test, and wear out models.

According to accelerated High Temperating Operating Life (HTOL) test.



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8 Transmission coefficients

8.1 TX - ANT 0.0 α/dB 1.0 حور 751. 2.0 1.95 3.0 4.0 5.0 760 770 780 790 800 f/MHz 0.0 20.0 40.0 60.0 0.08 675 725 800 650 750 775 825 700 850 f/MHz 0.0 ιШ 20.0 40.0 60.0 80.0

Figure 4: Attenuation TX – ANT.

1000

2000

3000

4000

5000

f/MHz -

6000



SAW duplexer 718.0 / 773.0 MHz

Data sheet

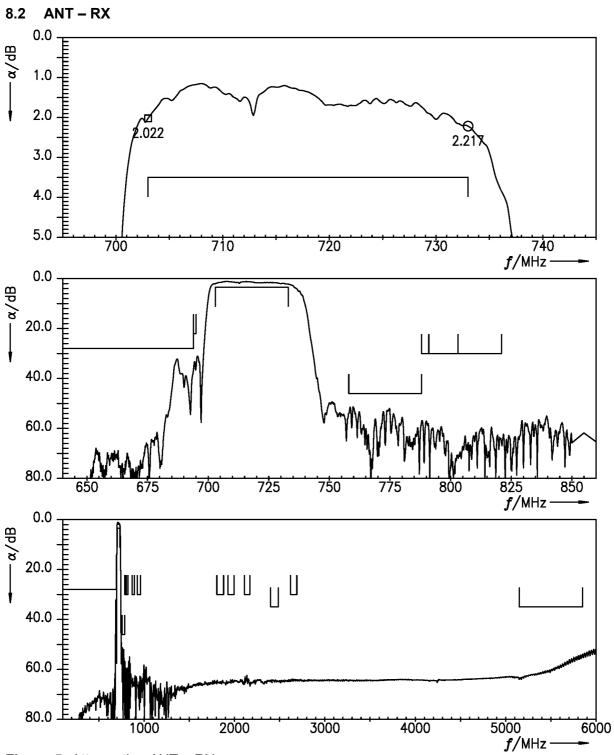


Figure 5: Attenuation ANT – RX.



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Data sheet

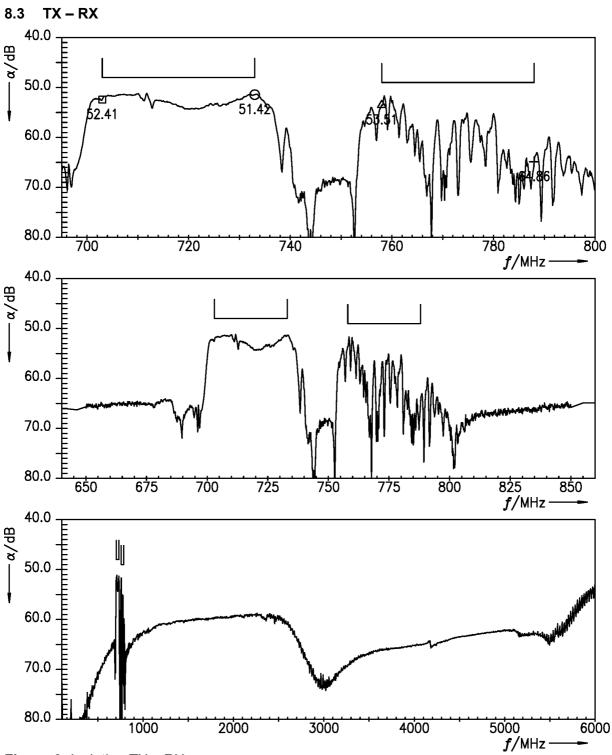


Figure 6: Isolation TX – RX.



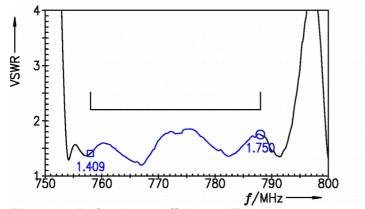
□ = 703.0 ○ = 733.0 □ = 758.0 ○ = 788.0

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9 Reflection coefficients



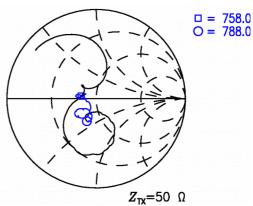


Figure 7: Reflection coefficient at TX port.

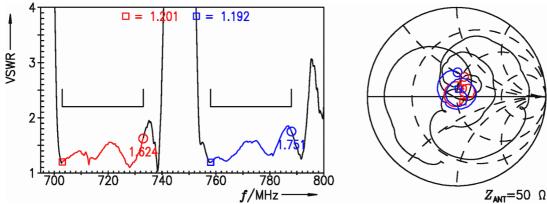


Figure 8: Reflection coefficient at ANT port (TX and RX frequencies).

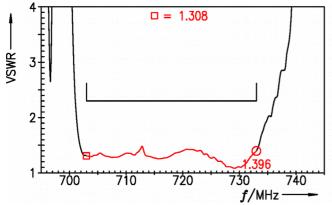
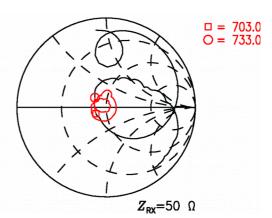


Figure 9: Reflection coefficient at RX port.





800

790

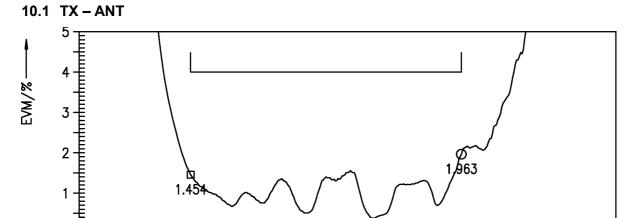
f/MHz

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10 EVMs



770

780

Figure 10: Error vector magnitude TX – ANT.

760



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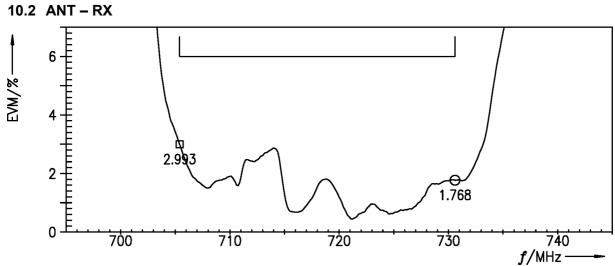


Figure 11: Error vector magnitude ANT – RX.

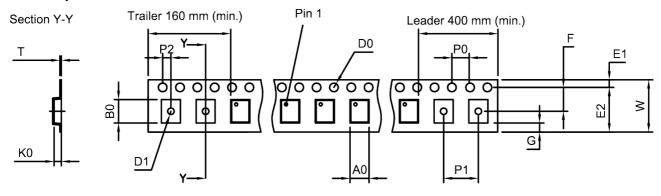


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11 Packing material

11.1 Tape



User direction of unreeling

Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	2.25±0.05 mm	E	6.25 mm (min.)	P	4.0±0.1 mm
B ₀	2.75±0.05 mm		F 3.5±0.05 mm	P:	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm		G 0.75 mm (min.)	Т	0.25±0.03 mm
D ₁	1.0 mm (min.)	ŀ	C ₀ 0.6±0.05 mm	W	8.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	F	P ₀ 4.0±0.1 mm		

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm

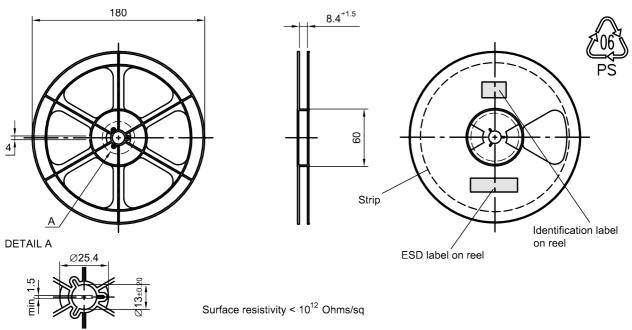


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.



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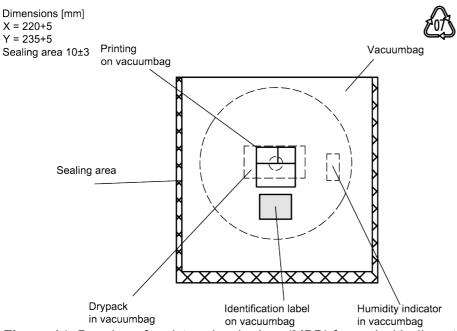


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

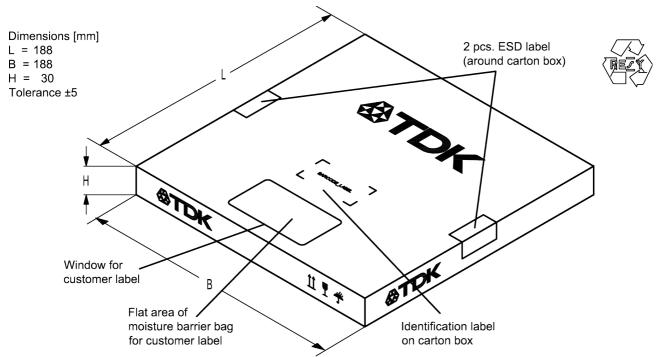


Figure 15: Drawing of folding box for reel with diameter of 180 mm.



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12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 = 1234

The BASE32 code for product type B8035 is 7V3.

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$ 12345

Adopted BASE32 code for type number				
Decimal	Base32	Decimal	Base32	
value	code	value	code	
0	0	16	G	
1	1	17	Н	
2	2	18	J	
3	3	19	K	
4	4	20	М	
5	5	21	N	
6	6	22	Р	
7	7	23	Q	
8	8	24	R	
9	9	25	S	
10	Α	26	Т	
11	В	27	V	
12	С	28	W	
13	D	29	Х	
14	E	30	Y	
15	F	31	Z	

Adopted BASE47 code for lot number					
Decimal	Base47	Decimal	Base47		
value	code	value	code		
0	0	24	R		
1	1	25	S		
2	2	26	Т		
3	3	27	U		
4	4	28	V		
5	5	29	W		
6	6	30	X		
7	7	31	Y		
8	8	32	Z		
9	9	33	b		
10	Α	34	d		
11	В	35	f		
12	С	36	h		
13	D	37	n		
14	E	38	r		
15	F	39	t		
16	G	40	V		
17	Н	41	\		
18	J	42	?		
19	K	43	{		
20	L	44	}		
21	M	45	<		
22	N	46	>		
23	Р				

Table 2: Lists for encoding and decoding of marking.



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13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

≤ 3 K/s
125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
30 s to 70 s
min. 10 s
max. 20 s
_
250 °C +0/-5 °C
230 °C +5/-0 °C for 10 s ± 1 s
≤ 3 K/s
measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

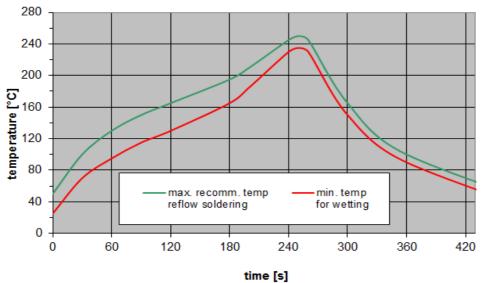


Figure 16: Recommended reflow profile for convection and infrared soldering – lead-free solder.



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14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39771B8035P810	5000 pcs

Table 4: Ordering codes and packing units.



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15 Cautions and warnings

15.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
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